

# RJK1529DPK

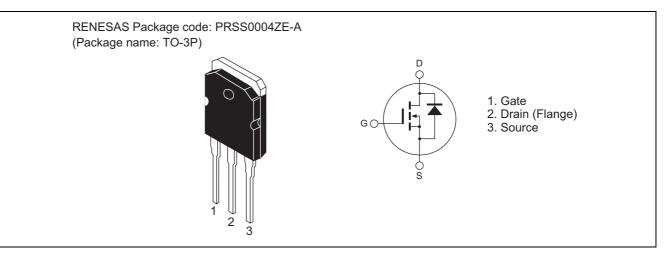
Silicon N Channel MOS FET High Speed Power Switching

> REJ03G0510-0200 Rev.2.00 Jun. 13, 2005

### Features

- Low on-resistance
- Low leakage current
- High speed switching

### Outline



### **Absolute Maximum Ratings**

		$(Ta = 25^{\circ}C)$
Symbol	Ratings	Unit
V <sub>DSS</sub>	150	V
V <sub>GSS</sub>	±30	V
I <sub>D</sub>	70	А
Note1 D (pulse)	210	А
I <sub>DR</sub>	70	А
Note1 DR (pulse)	210	А
I <sub>AP</sub> <sup>Note3</sup>	35	А
E <sub>AR</sub> <sup>Note3</sup>	91.8	mJ
Pch Note2	150	W
θch-c	0.833	°C/W
Tch	150	۵°
Tstg	-55 to +150	۵°
	V <sub>DSS</sub> V <sub>GSS</sub> I <sub>D</sub> I <sub>D (pulse)</sub> <sup>Note1</sup> I <sub>DR</sub> I <sub>DR (pulse)</sub> I <sub>DR</sub> Note3 I <sub>AP</sub> <sup>Note3</sup> E <sub>AR</sub> <sup>Note3</sup> E <sub>AR</sub> <sup>Note3</sup> Pch <sup>Note2</sup> θch-c Tch	V <sub>DSS</sub> 150           V <sub>GSS</sub> ±30           I <sub>D</sub> 70           I <sub>D</sub> (pulse)         210           I <sub>DR</sub> 70           I <sub>DR</sub> (pulse)         210           I <sub>DR</sub> (pulse)         210           I <sub>AP</sub> Note3         35           E <sub>AR</sub> Note3         91.8           Pch <sup>Note2</sup> 150           θch-c         0.833           Tch         150

Notes: 1.  $PW \le 10 \ \mu s$ , duty cycle  $\le 1\%$ 

- 2. Value at Tc =  $25^{\circ}$ C
- 3. STch =  $25^{\circ}$ C, Tch  $\leq 150^{\circ}$ C



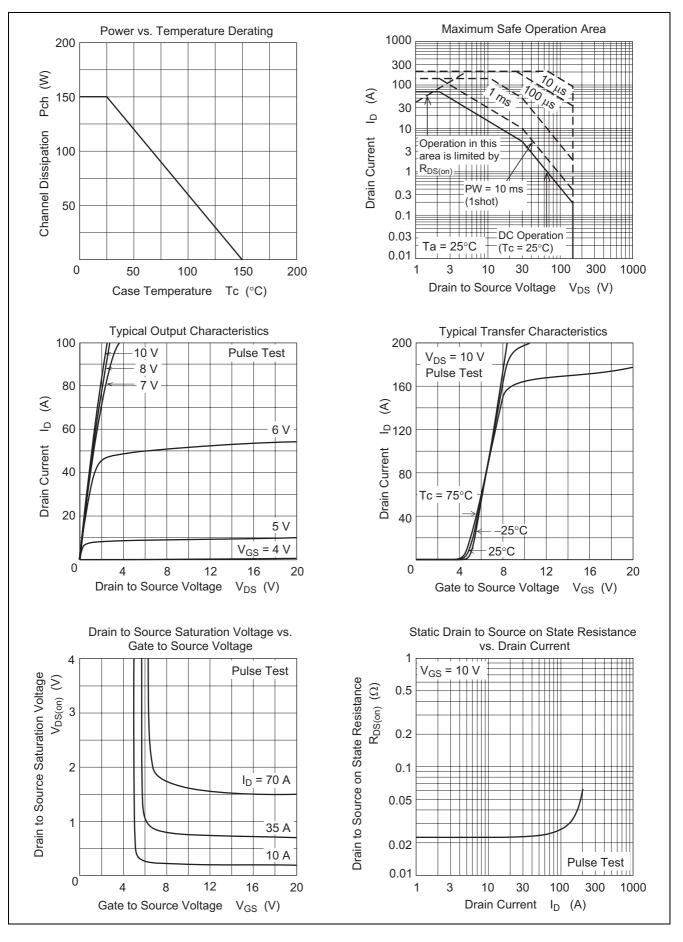
# **Electrical Characteristics**

					$(Ta = 25^{\circ}C)$
Symbol	Min	Тур	Max	Unit	Test conditions
V <sub>(BR)DSS</sub>	150	—		V	$I_D = 10 \text{ mA}, V_{GS} = 0$
I <sub>DSS</sub>	_	—	1	μΑ	$V_{DS} = 150 \text{ V}, \text{ V}_{GS} = 0$
I <sub>GSS</sub>	_	—	±0.1	μΑ	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0$
V <sub>GS(off)</sub>	3.0	—	4.5	V	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ mA}$
yfs	25	43		S	$I_D = 35 \text{ A}, V_{DS} = 10 \text{ V}^{Note4}$
R <sub>DS(on)</sub>	_	0.022	0.025	Ω	$I_D = 35 \text{ A}, V_{GS} = 10 \text{ V}^{Note4}$
Ciss	_	2900		pF	V <sub>DS</sub> = 25 V
Coss	_	600		pF	V <sub>GS</sub> = 0 f = 1 MHz
Crss		78		pF	
t <sub>d(on)</sub>	_	40		ns	I <sub>D</sub> = 35 A
tr		270		ns	$V_{GS} = 10 V$ R <sub>L</sub> = 2.14 Ω Rg = 10 Ω
t <sub>d(off)</sub>		110		ns	
t <sub>f</sub>	_	170		ns	
Qg	_	74		nC	$V_{DD} = 120 V$ $V_{GS} = 10 V$ $I_D = 70 A$
Qgs	_	19		nC	
Qgd	_	35		nC	
$V_{DF}$		0.95	1.50	V	$I_F = 70 \text{ A}, V_{GS} = 0^{Note4}$
trr		140	_	ns	$I_F = 70 \text{ A}, V_{GS} = 0$ diF/dt = 100 A/µs
Qrr	—	0.6	—	μC	
	V(BR)DSS           IDSS           IGSS           VGS(off)           Jyfs]           RDS(on)           Ciss           Coss           Crss           td(on)           tr           dd(off)           tf           Qg           Qgd           VDF           trr	V(BR)DSS         150           IDSS            IGSS            VGS(off)         3.0           Jyfs         25           RDS(on)            Ciss            Coss            Crss            td(on)            tf            Qg            Qgs            Qgd            VDF            trr	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$

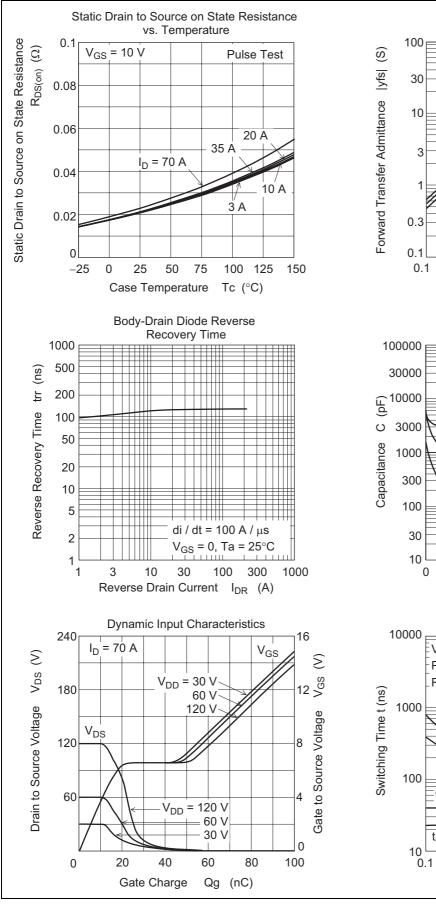
Notes: 4. Pulse test

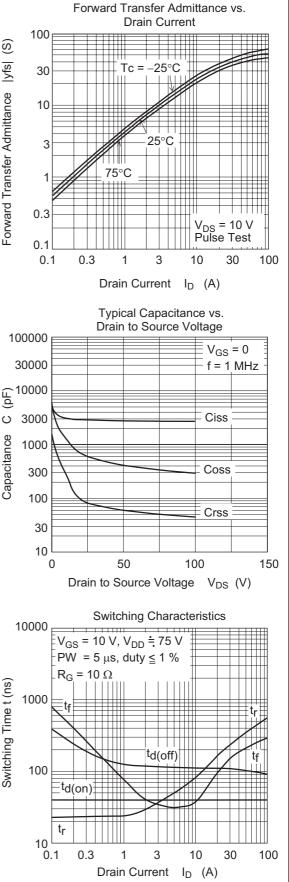


### **Main Characteristics**

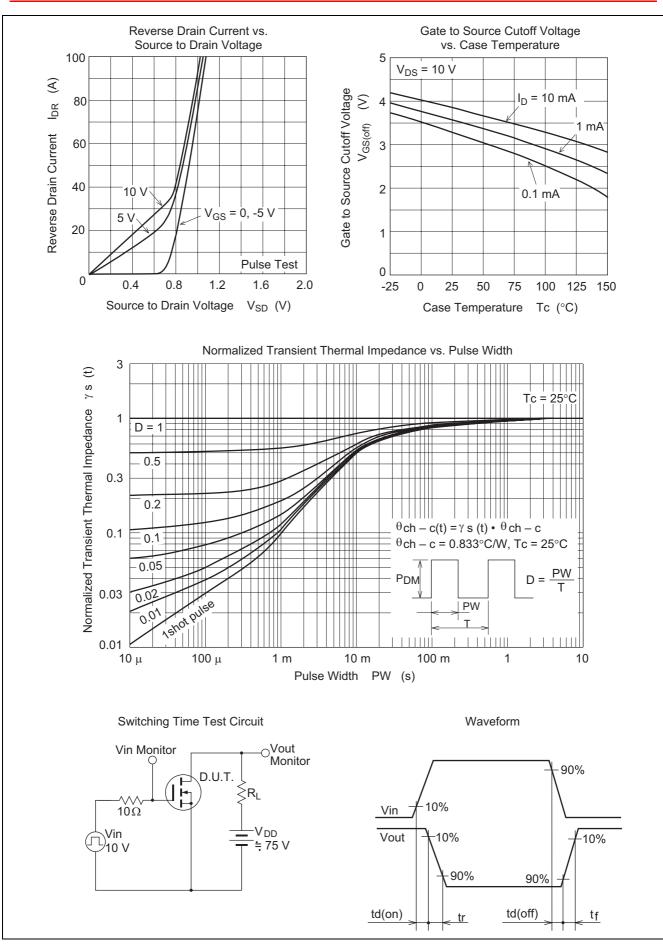






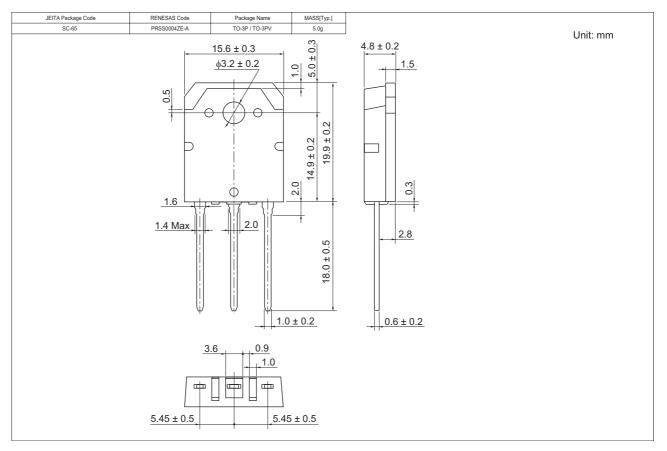








### **Package Dimensions**



### **Ordering Information**

Part Name	Quantity	Shipping Container	
RJK1529DPK-E	30 pcs	Plastic magazine	

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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